## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
PHILIPPE SARTORI	01/14/2014
VIPUL DESAI	01/14/2014
HOSSEIN BAGHERI	02/03/2014
ANTHONY SOONG	02/07/2014

### **RECEIVING PARTY DATA**

Name:	FutureWei Technologies, Inc.
Street Address:	5340 Legacy Drive
Internal Address:	Suite 175
City:	Plano
State/Country:	TEXAS
Postal Code:	75024

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14207197

### **CORRESPONDENCE DATA**

**Fax Number:** (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

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Address Line 2: SUITE 1000

Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	HW 81085550US03
NAME OF SUBMITTER:	CLAUDETTE L. HOFFMANN
SIGNATURE:	/Claudette L. Hoffmann/
DATE SIGNED:	04/02/2014

**Total Attachments: 3** 

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502750280 PATENT REEL: 032582 FRAME: 0980

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PATENT REEL: 032582 FRAME: 0981

### **ASSIGNMENT**

WHEREAS, I/We, the undersigned inventor(s) (or one of the undersigned joint inventors), of residence as listed below, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Futurewei Technologies, Inc. ("Assignee"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024 is desirous of acquiring my/our entire right, title and interest in the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we will assign, and hereby assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive right, title and interest in and to the invention in the United States and every foreign country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisional, reissues, reexaminations, National Phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every foreign country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and I/we do hereby authorize and request the Commissioner for Patents to issue U.S. patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the Assignee agreeably with the terms of this assignment document.

I also hereby agree to sell and to assign, and sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to Assignee, or its successors, assigns, and legal representative, any facts know to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid such Futurewei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

Futurewei Technologies, Inc.
Patent Reference No.: HW 81085550US03

Page 1 of 2

## ASSIGNMENT

# IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	itle of Invention System and Method for Time-Power-Frequence for D2D Discovery	
•	Appl. No.	Filing Date:
Signature of Inventor		
Inventor Name	Philippe Sartori	
Date	01-14-2014	
Residence (City/Sate)	Algoritinal POTT PLANNELED IL	
Signature of Inventor	7/4 //som"	
Inventor Name	Vipul Desai	
Date	JAM 189 14,2014	
Residence (City/Sate)	Palatine, IL	
Signature of Inventor		
Inventor Name	Hossein Bagheri	
Date	Feb3, 2014	
Residence	Arlington Heights, II.	
(City/Sate)		
Signature of Inventor		
Inventor Name Date	Anthony Soong	
Residence (City/Sate)	Plano, TX	

Futurewei Technologies, Inc. Patent Reference No.: HW 81085550USo3

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## **ASSIGNMENT**

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	System and Method for Time-Power-Frequency Hopping for D2D Discovery	
	Appl. No.	Filing Date:
Signature of		
Inventor		
Inventor Name	Philippe Sartori	
Date		
Residence	Plainfield, IL	
(City/Sate)		
Signature of		
Inventor		
Inventor Name	Vipul Desai	
Date		
Residence	Palatine, IL	
(City/Sate)		
Signature of		
Inventor		
Inventor Name	Hossein Bagheri	
Date		
Residence	Arlington Heights, IL	
(City/Sate)		
Signature of	- 111-111 - 11	
Inventor	and the second	
Inventor Name	Anthony Soong	
Date	Feb. 7, 2014	
Residence	Plano, TX	
(City/Sate)		

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